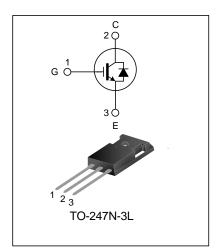
50A, 650V FIELD STOP IGBT

DESCRIPTION

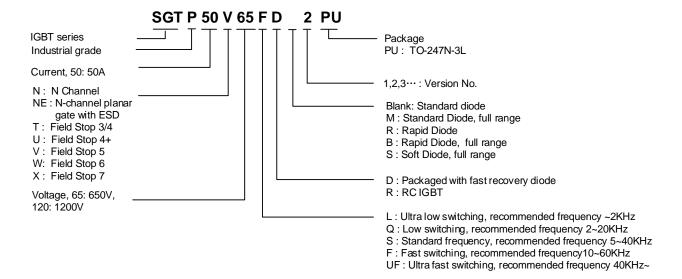
The SGTP50V65FD2PU Field Stop IGBT adopts Silan Field Stop V technology, features low conduction loss and switching loss. This device is applicable to photovoltaic, UPS, SMPS, and PFC fields.

FEATURES

- ◆ 50A, 650V, V_{CE(sat)(typ.)}=1.65V@I_C=50A
- Low conduction loss
- Ultra-fast switching
- High input impedance
- T_{Jmax.}=175°C



NOMENCLATURE



ORDERING INFORMATION

Part No.	Part No. Package Marking		Hazardous Substance Control	Packing Type	
SGTP50V65FD2PU	TO-247N-3L	P50V65FD2PU	Halogen free	Tube	

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ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, Tc=25°C)

Characteristics		Symbol	Ratings	Unit
Collector to Emitter Voltage		V _{CE}	650	V
Gate to Emitter Vol	tage	V_{GE}	±20	V
Transient Gate-Em (t _p ≤10µs, D<0.01	•	V_{GE}	±30	V
Callagtar Current	T _C =25°C	Ic	100	۸
Collector Current	T _C =100°C		50	Α
Pulsed Collector Current		Ісм	150	Α
Diada Current	T _C =25°C	- I _F	16	۸
Diode Current	T _C =100°C		8	Α
Pulsed Diode Current		I _{FM}	32	Α
Power Dissipation (T _C =25°C)		P _D	273	W
Operating Junction Temperature		TJ	-40∼+175	°C
Storage Temperature Range		T _{stg}	-55∼+150	°C

THERMAL CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Thermal Resistance, Junction to Case	R _{0JC}				0.55	°C/W
(IGBT)	KejC				0.55	C/VV
Thermal Resistance, Junction to Case	D				2.7	°C/W
(FRD)	R _{eJC}				2.1	-0/٧٧
Thermal Resistance, Junction to	В				40	0000
Ambient (IGBT)	$R_{\theta JA}$				40	°C/W
Soldering Temperature (in line)	T _{sold}	15 ⁺² ₋₀ sec, 1time			260	°C

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ELECTRICAL CHARACTERISTICS OF IGBT (UNLESS OTHERWISE NOTED, Tc=25°C)

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Collector to Emitter Breakdown Voltage	BV _{CE}	V _{GE} =0V, I _C =250μA	650			V
C-E Leakage Current	I _{CES}	V _{CE} =650V, V _{GE} =0V			40	μA
G-E Leakage Current	I _{GES}	V _{GE} =20V, V _{CE} =0V			±100	nA
G-E Threshold Voltage	V _{GE(th)}	I _C =250uA, V _{CE} =V _{GE}	3.2	4.0	5.0	V
Collector to Emitter	\/	I _C =50A, V _{GE} =15V, T _C =25°C		1.65	2.3	V
Saturation Voltage	$V_{CE(sat)}$	I _C =50A, V _{GE} =15V, T _C =175°C		2.0		V
Input Capacitance	C _{ies}	V 20V		3614		
Output Capacitance	C _{oes}	V _{CE} =30V		69		, r
Reverse Transfer Capacitance	C _{res}	V _{GE} =0V f=1MHz		13		pF
Turn-On Delay Time	T _{d(on)}			42		ns
Rise Time	T _r	V _{CE} =400V		26		
Turn-Off Delay Time	T _{d(off)}	I_{C} =50A R_{g} =10 Ω V_{GE} =15 V inductive load T_{C} =25° C		180		
Fall Time	T _f			22		
Turn-On Switching Loss	Eon			0.48		
Turn-Off Switching Loss	E _{off}			0.82		mJ
Total Switching Loss	E _{st}	1c=25°C		1.30		
Turn-On Delay Time	T _{d(on)}			36		
Rise Time	Tr	V _{CE} =400V		18		
Turn-Off Delay Time	T _{d(off)}	I _C =25A		188		ns
Fall Time	T _f	$R_g=10\Omega$		21		
Turn-On Switching Loss	Eon	V _{GE} =15V		0.16		
Turn-Off Switching Loss	E _{off}	inductive load T _C =25°C		0.39		mJ
Total Switching Loss	E _{st}	1 C=20 C		0.55		
Total Gate Charge	Qg			131		
Gate to Emitter Charge	Q _{ge}	V _{CE} =520V, I _C =50A, V _{GE} =15V		26		nC
Gate to Collector Charge	Q_{gc}			35		

ELECTRICAL CHARACTERISTICS OF FRD (UNLESS OTHERWISE NOTED, Tc=25°C)

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Diode Forward Voltage	\	I _F =8A, T _C =25°C		1.9	2.4	V
	V_{FM}	I _F =8A, T _C =175°C		1.4		
Diode Reverse Recovery	_			27		20
Time	T_{rr}			21		ns
Diode Reverse Recovery	Q _{rr}	I _{ES} =8A, dI _{ES} /dt=200A/μs,		50		nC
Charge		V _R =50V, T _C =25°C				
Diode Reverse Recovery	Irm			3.6		۸
Current				3.6		А

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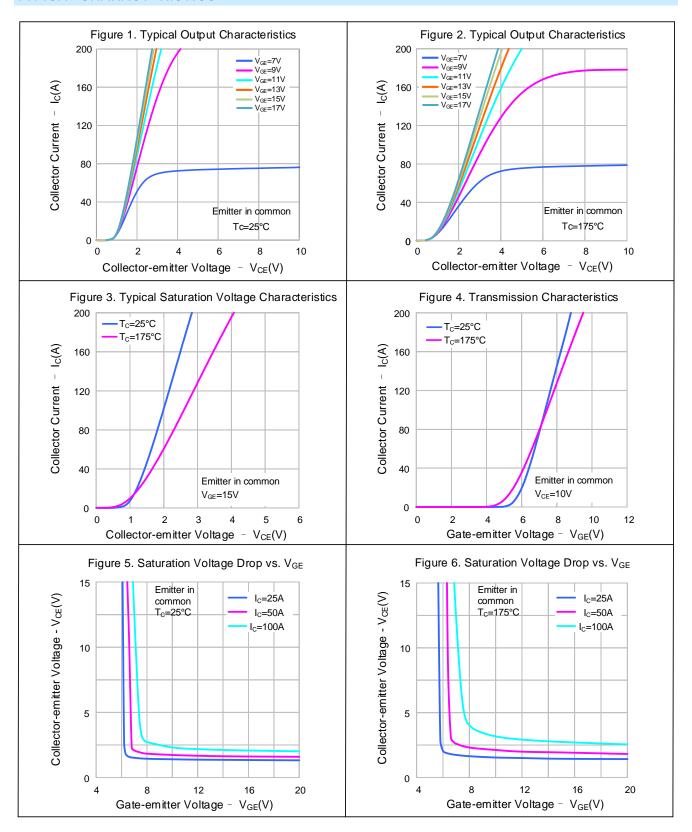
ELECTRICAL CHARACTERISTICS OF IGBT (Tc=175°C)

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Turn-On Delay Time	$T_{d(on)}$	1001		40		
Rise Time	T _r	V _{CE} =400V	1	28		ns
Turn-Off Delay Time	$T_{d(off)}$	$I_{C}=50A$ $R_{o}=10\Omega$	1	214		115
Fall Time	T _f	$V_{GE}=15V$		28		
Turn-On Switching Loss	E _{on}			0.62		
Turn-Off Switching Loss	E _{off}	inductive load - T _C =175°C		1.09		mJ
Total Switching Loss	E _{st}			1.71		
Turn-On Delay Time	T _{d(on)}	V 400V		36		
Rise Time	Tr	V _{CE} =400V	1	18		ns
Turn-Off Delay Time	$T_{d(off)}$	I_{C} =25A $ R_{g}$ =10 Ω $ V_{GE}$ =15 V $-$ inductive load $ T_{C}$ =175°C $-$		234		115
Fall Time	T _f		1	25		
Turn-On Switching Loss	Eon		1	0.20		
Turn-Off Switching Loss	E _{off}		-	0.52		mJ
Total Switching Loss	E _{st}	10-170 0		0.72		

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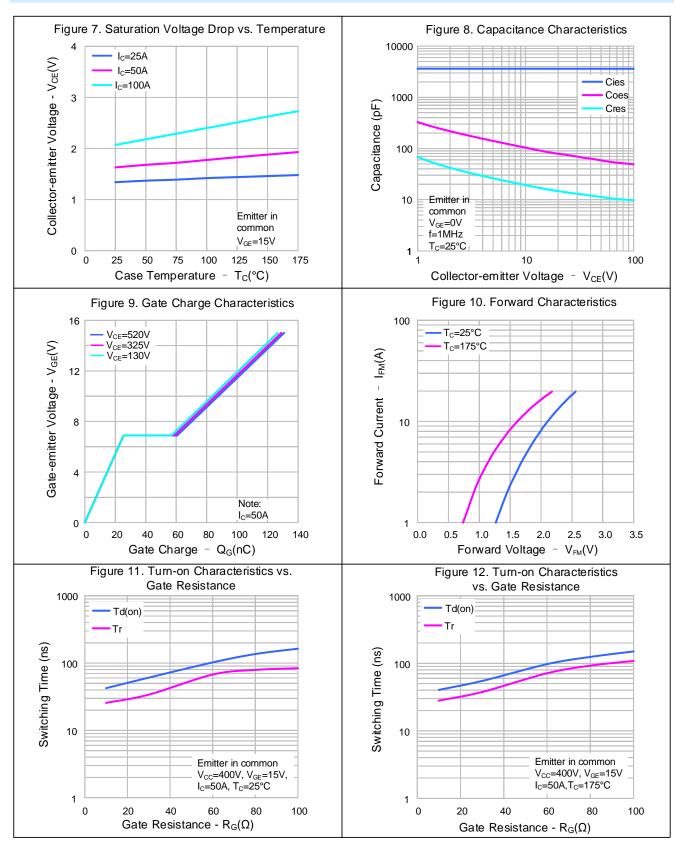


TYPICAL CHARACTERISTICS



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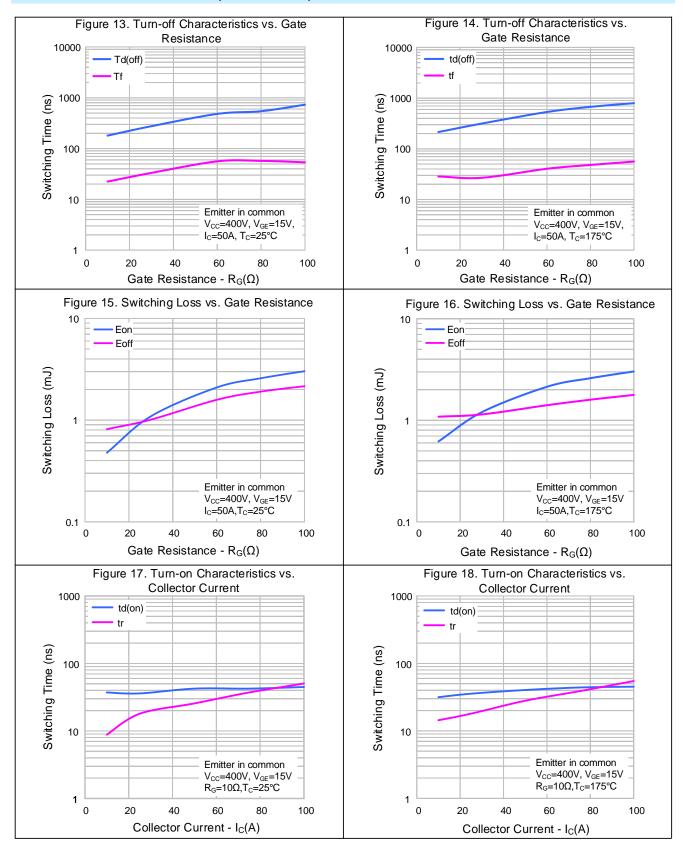
TYPICAL CHARACTERISTICS (CONTINUED)



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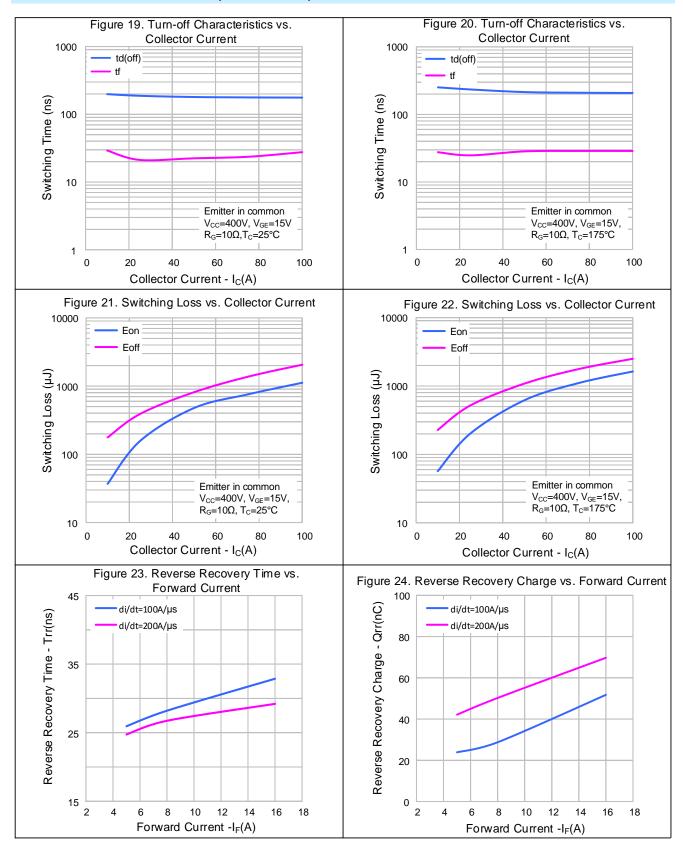
TYPICAL CHARACTERISTICS (CONTINUED)



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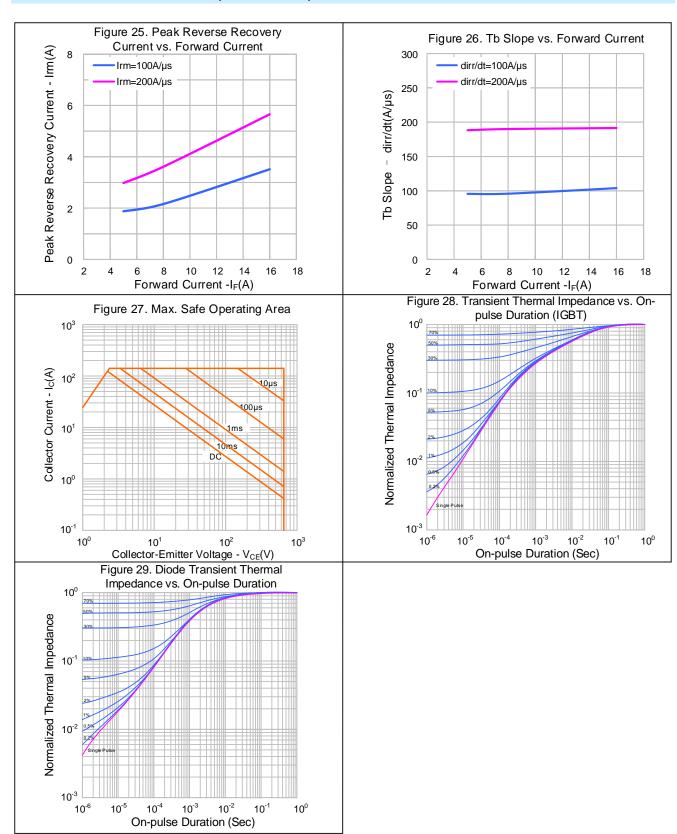


TYPICAL CHARACTERISTICS (CONTINUED)





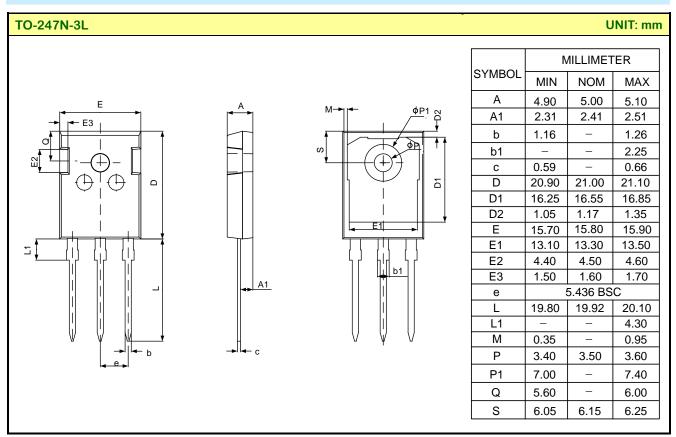
TYPICAL CHARACTERISTICS (CONTINUED)



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PACKAGE OUTLINE





MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

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Important notice:

- Silan reserves the right to make changes of this instruction without notice.
- 2. Customers should obtain the latest relevant information when purchasing and should verify whether such information is latest and complete. Please read this instruction and application manual and related materials carefully before using products, including the circuit operation precautions, etc.
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1.0 Rev.: Revision History:

First release

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